

Dual N-channel MOSFET

ELM14800AA-N

<http://www.elm-tech.com>

■ General description

ELM14800AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge.

■ Features

- $V_{ds}=30V$
- $I_d=6.9A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 27m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 32m\Omega$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 50m\Omega$ ($V_{gs}=2.5V$)

■ Maximum absolute ratings

$T_a=25^\circ C$. Unless otherwise noted.

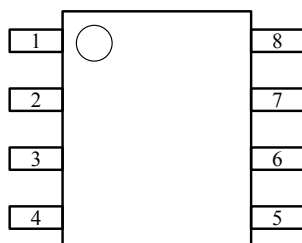
Parameter	Symbol	Limit	Unit	Note	
Drain-source voltage	V_{ds}	30	V		
Gate-source voltage	V_{gs}	± 12	V		
Continuous drain current	I_d	$T_a=25^\circ C$	6.9	A	1
		$T_a=70^\circ C$	5.8		
Pulsed drain current	I_{dm}	40	A	2	
Power dissipation	P_d	$T_c=25^\circ C$	2.00	W	
		$T_c=70^\circ C$	1.44		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	$^\circ C$		

■ Thermal characteristics

Parameter	Symbol	Typ.	Max.	Unit	Note
Thermal resistance junction-to-ambient	$R_{\theta ja}$	48.0	62.5	$^\circ C/W$	1
Thermal resistance junction-to-ambient		$t \leq 10s$	74.0	110.0	
Thermal resistance junction-to-lead	$R_{\theta jl}$	35.0	40.0	$^\circ C/W$	3

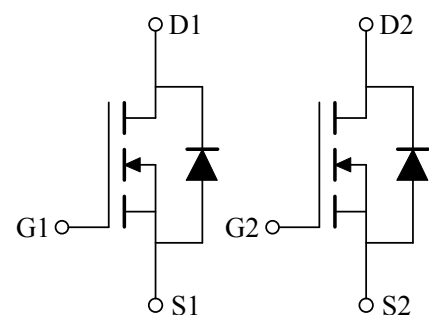
■ Pin configuration

SOP-8(TOP VIEW)



Pin No.	Pin name
1	SOURCE2
2	GATE2
3	SOURCE1
4	GATE1
5	DRAIN1
6	DRAIN1
7	DRAIN2
8	DRAIN2

■ Circuit



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■ Electrical characteristics

Ta=25°C. Unless otherwise noted.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=250μA, Vgs=0V	30			V	
Zero gate voltage drain current	Idss	Vds=24V, Vgs=0V		0.002	1.000	μA	
			Ta=55°C		5.000		
Gate-body leakage current	Igss	Vds=0V, Vgs=±12V			100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250μA	0.7	1.0	1.4	V	
On state drain current	Id(on)	Vgs=4.5V, Vds=5V	25			A	
Static drain-source on-resistance	Rds(on)	Vgs=10V, Id=6.9A	Ta=125°C		22.6	27.0	mΩ
					33.0	40.0	
				Vgs=4.5V, Id=6A	27.0	32.0	
		Vgs=2.5V, Id=5A		42.0	50.0		
Forward transconductance	Gfs	Vds=5V, Id=5A	12	16		S	
Diode forward voltage	Vsd	Is=1A		0.71	1.00	V	
Max. body-diode continuous current	Is				3	A	
DYNAMIC PARAMETERS							
Input capacitance	Ciss			858	1050	pF	
Output capacitance	Coss	Vgs=0V, Vds=15V, f=1MHz		110		pF	
Reverse transfer capacitance	Crss			80		pF	
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		1.24	3.60	Ω	
SWITCHING PARAMETERS							
Total gate charge	Qg			9.60	12.00	nC	
Gate-source charge	Qgs	Vgs=4.5V, Vds=15V, Id=6.9A		1.65		nC	
Gate-drain charge	Qgd			3.00		nC	
Turn-on delay time	td(on)			3.2	4.8	ns	
Turn-on rise time	tr	Vgs=10V, Vds=15V		4.1	6.2	ns	
Turn-off delay time	td(off)	RL=2.2Ω, Rgen=3Ω		26.3	40.0	ns	
Turn-off fall time	tf			3.7	5.5	ns	
Body diode reverse recovery time	trr	If=5A, dIf/dt=100A/μs		15.5	20.0	ns	
Body diode reverse recovery charge	Qrr	If=5A, dIf/dt=100A/μs		7.9	12.0	nC	

NOTE :

1. The value of Rθja is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with Ta=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The Rθja is the sum of the thermal impedance from junction to lead Rθjl and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with Ta=25°C. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics

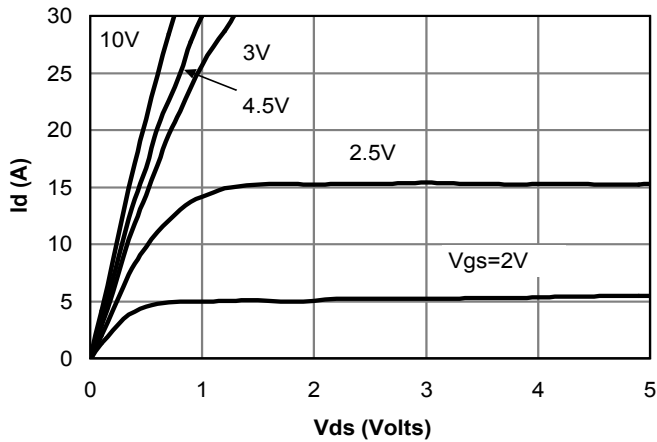


Fig 1: On-Region Characteristics

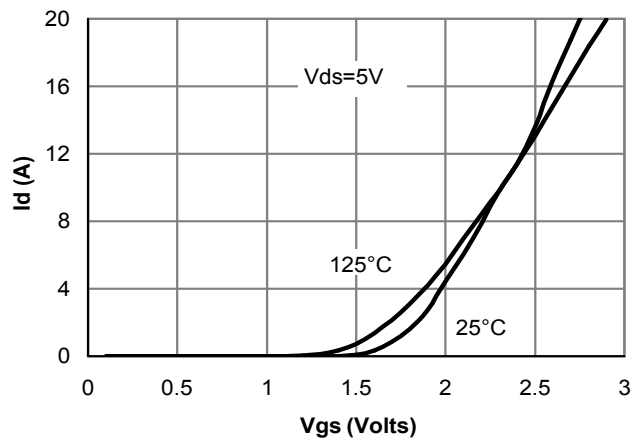


Figure 2: Transfer Characteristics

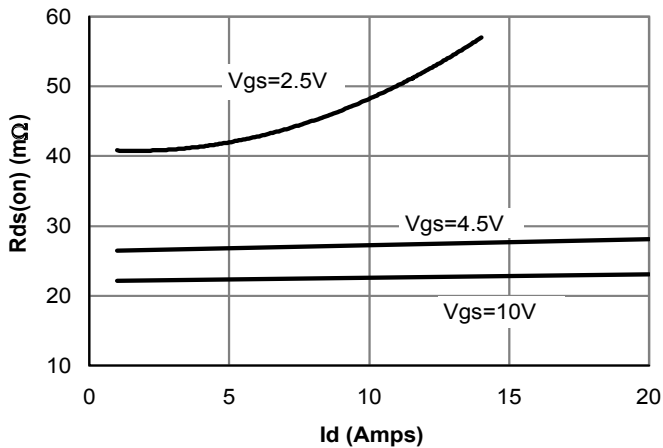


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

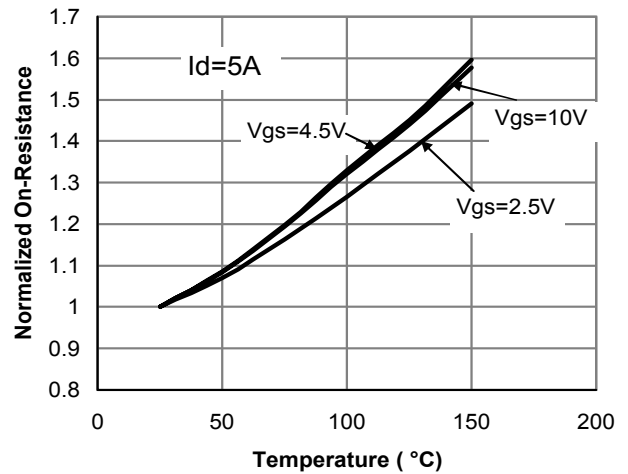


Figure 4: On-Resistance vs. Junction Temperature

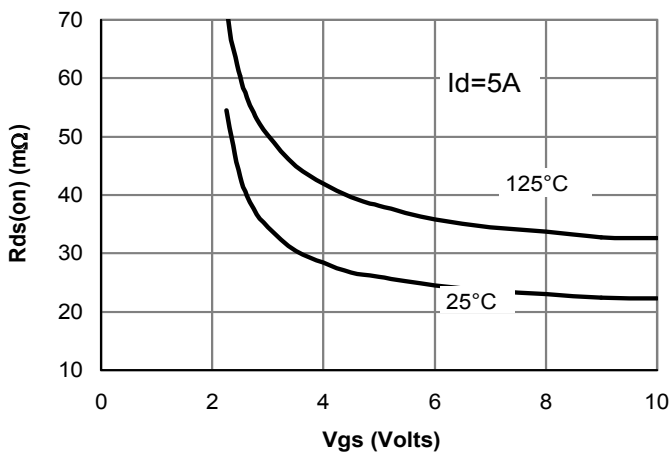


Figure 5: On-Resistance vs. Gate-Source Voltage

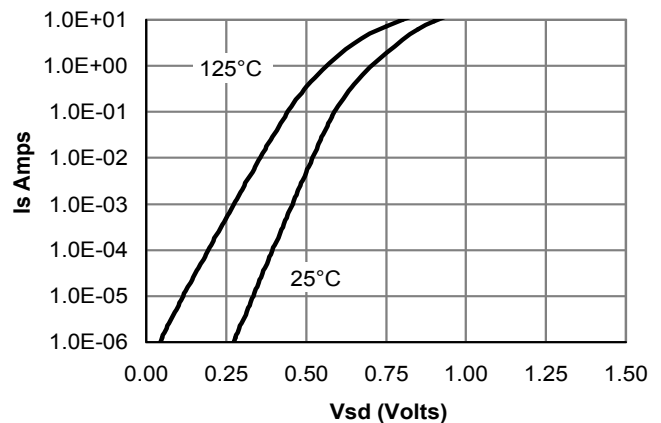


Figure 6: Body diode characteristics

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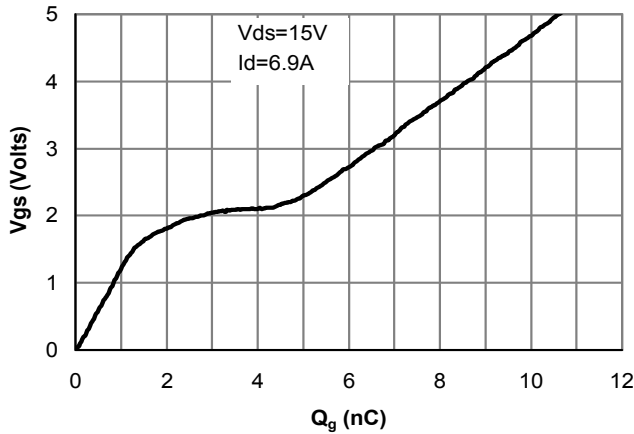


Figure 7: Gate-Charge characteristics

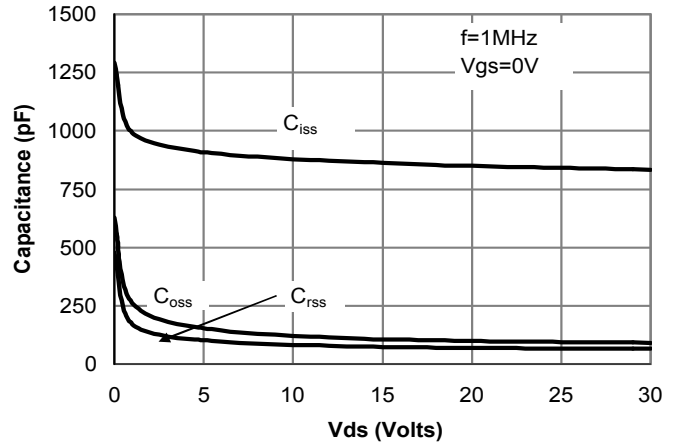


Figure 8: Capacitance Characteristics

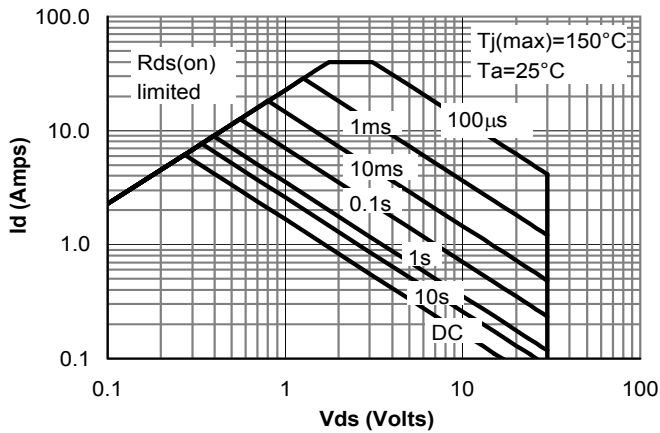


Figure 9: Maximum Forward Biased Safe Operating Area (Note 5)

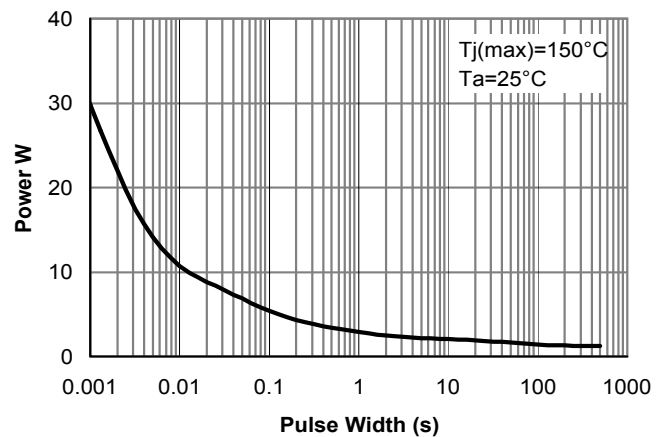


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note 5)

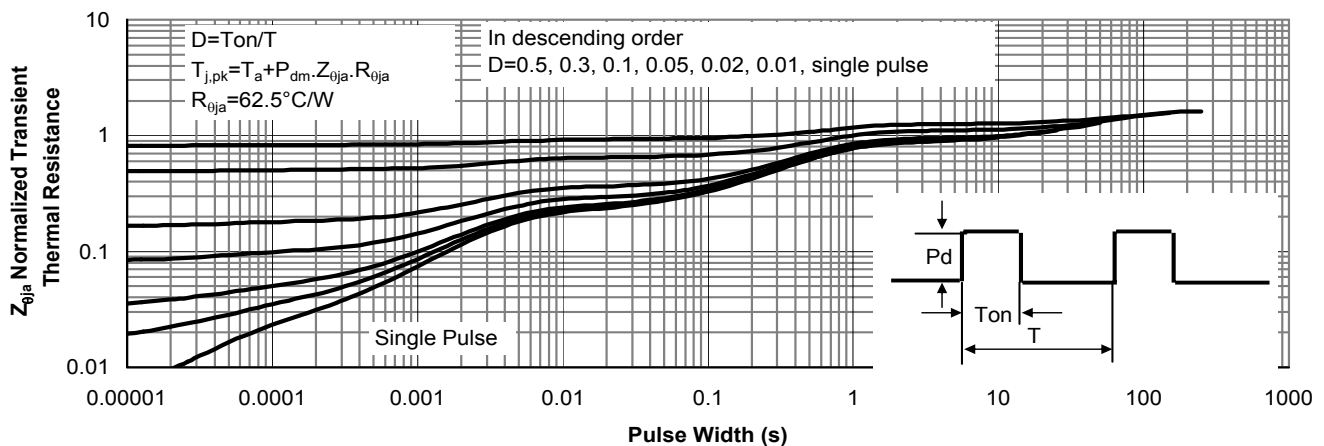


Figure 11: Normalized Maximum Transient Thermal Impedance